## 503063872 11/17/2014

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3110474

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
YOSHIYUKI KUROKAWA	11/04/2014

#### **RECEIVING PARTY DATA**

Name:	SEMICONDUCTOR ENERGY LABORATORY CO., LTD.
Street Address:	398, HASE
City:	ATSUGI-SHI, KANAGAWA-KEN
State/Country:	JAPAN
Postal Code:	243-0036

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	14542859

### **CORRESPONDENCE DATA**

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Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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ATTORNEY DOCKET NUMBER:	12732-1376001
NAME OF SUBMITTER:	APRIL K. SAUNDERS-FULLER
SIGNATURE:	/April K. Saunders-Fuller/
DATE SIGNED:	11/17/2014

**Total Attachments: 1** 

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PATENT 503063872 REEL: 034186 FRAME: 0312

Attorney Docket No. 12732-1376001 Client Reference No. US19668

# **ASSIGNMENT**

For valuable consideration, I, <u>Yoshiyuki KUROKAWA of Sagamihara, Kanagawa, Japan</u> hereby assign to <u>Semiconductor Energy Laboratory Co.</u>, <u>Ltd.</u>, a <u>Japanese</u> corporation having a place of business at:

398, Hase, Atsugi-shi, Kanagawa-ken, 243-0036 Japan

and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title and interest throughout the world in the inventions and improvements which are subject of an application for States Patent signed by me this day, entitled **SEMICONDUCTOR** DEVICE, United filed 11/17/2014 \_\_\_\_, and assigned U.S. Serial Number <u>14/542,859</u>, and I authorize and request the Assignee or the attorneys appointed in said application to hereafter complete this assignment by inserting above the filing date and serial number of said application when known; this assignment including said application, any and all United States and foreign patents, utility models, and design registrations granted for any of said inventions or improvements, and the right to claim priority based on the filing date of said application under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and I authorize the Assignee to apply in all countries in my name or in its own name for patents, utility models, design registrations and like rights of exclusion and for inventors' certificates for said inventions and improvements; and I agree for myself and my respective heirs, legal representatives and assigns, without further compensation to perform such lawful acts and to sign such further applications, assignments, Preliminary Statements and other lawful documents as the Assignee may reasonably request to effectuate fully this assignment.

Signature	Yoshiyuki Kurokawa
Name:	Yoshiyuki KUROKAWA
Date:	11/04/2014

**RECORDED: 11/17/2014** 

PATENT REEL: 034186 FRAME: 0313